



PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,

Tel: 886-2-2225-3733 Fax: 886-2-2225-4800 E-mail: para@para.com.tw www.paralighttaiwan.com

DATA SHEET

PART NO.: L-C191LGCT-BIC-5A

REV: A/0

CUSTOMER'S APPROVAL: DCC:

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 1 of 13

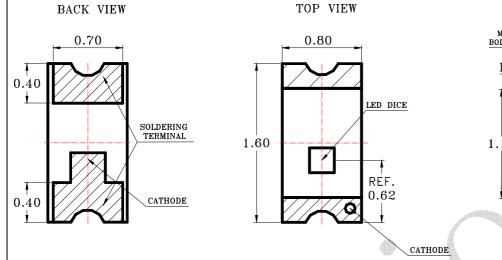


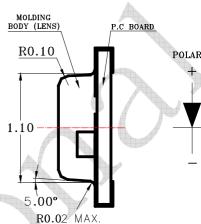


Part No.: L-C191LGCT-BIC-5A

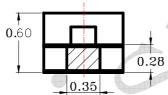
REV:A/0

PACKAGE OUTLINE DIMENSIONS





SIDE VIEW



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.1mm (.004") unless otherwise noted.

Features

- * Top view, wide view angle, single color Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Infrared and Wave soldering reflow solder processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.
- * Meet RoHS Green Product.

DRAWING NO. : DS-74-18-XXXX DATE : 2018-8-10 PAGE 2 of 13





Part No.: L-C191LGCT-BIC-5A

REV:A/0

• Chip Materials

Dice Material : InGaNLight Color : Super GreenLens Color : Water Clear

● Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	100	mW
Ipf	Peak Forward Current	100	A
IPF	(1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
IF	Continuous Forward Current	25	mA
-	De-rating Linear From 25°C	0.25	mA/°C
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM) ^{Note A}	1000	V
Topr	Operating Temperature Range	- 40 ∼ +85	$^{\circ}\!\mathbb{C}$
Tstg	Storage Temperature Range	- 40 ∼ +85	$^{\circ}\mathbb{C}$

Note A:

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

● Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	112	230		mcd	IF=5mA
Viewing Angle	2 θ 1/2		130		deg	Note 2
Peak Emission Wavelength	λp		518		nm	Measurement @Peak
Dominant Wavelength	λd		528		nm	IF=5mA
Spectral Line Half-Width	Δλ		15		nm	
Forward Voltage	VF		2.55	2.9	V	IF =5mA
Reverse Current	IR			50	μА	VR = 5V

DRAWING NO. : DS-74-18-XXXX DATE : 2018-8-10 PAGE 3 of 13





Part No.: L-C191LGCT-BIC-5A

REV:A/0

Bin Code List

Luminous Intensity(IV), Unit:mcd@5mA			
Bin Code	Min	Max	
R	112	180	
S	180	280	
Т	280	450	

Forward Voltage(VF), Unit:V@5mA			
Bin Code	Min	Max	
J6	2.45	2.6	
J7	2.6	2.75	
J8	2.75	2.9	

Tolerance of each bin are $\pm 15\%$

Tolerance of each bin are ± 0.1 Volt

Dominant Wavelength (Hue),Unit: nm@5mA				
Bin Code	Min	Max		
AQ	525	530		
AR	530	535		

Tolerance of each bin are ± 1 nm

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:
 - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 4 of 13



Part No.: L-C191LGCT-BIC-5A

REV:A/0

Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

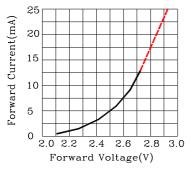


Fig.2 Forward Current vs.Forward Voltage

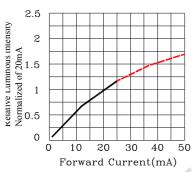


Fig.4 Relative Luminous Intensity vs.Forward Current

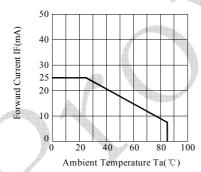


Fig.6 Forward Current Derating Curve

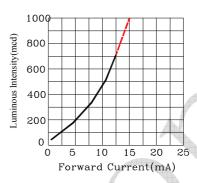


Fig.3 Luminous Intensity vs.Forward Current

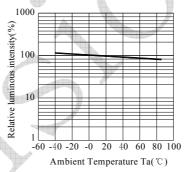


Fig.5 Luminous Intensity vs. Ambient Temperature

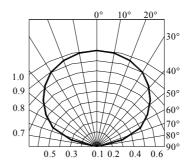


Fig.7 Relative Intensity vs.Angle

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 5 of 13





Part No.: L-C191LGCT-BIC-5A

REV:A/0

Label Explanation



ITEM CODE:PARA LIGHT

PART NO: L-C191LGCT-BIC-5A

IV --- Luminous Intensity Code

LOT NO: <u>EM S L 12 09</u> 0110 A B C D E F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG:

3000pcs for 150, 170, 110, 155, 115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10

G H I

G--- Year

H--- Month

I --- Day

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 6 of 13





Part No.: L-C191LGCT-BIC-5A

REV:A/0

Typical Electro-Optical Characteristics Curves

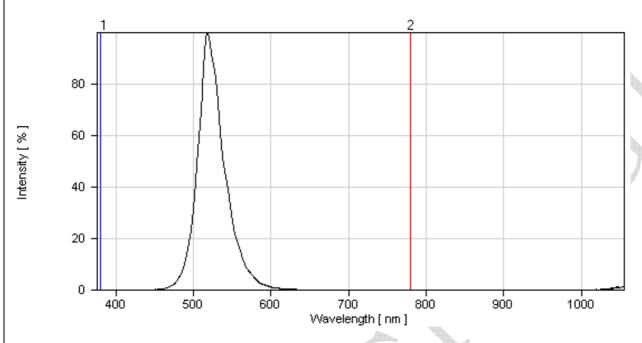
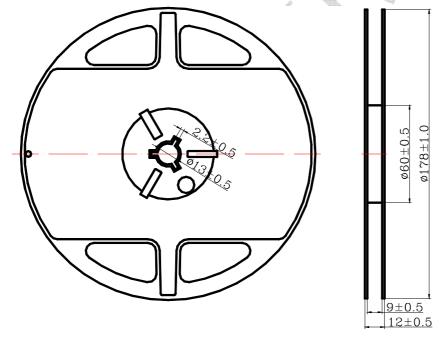


Fig.1 Relative Intensity vs. Wavelength

Reel Dimensions



Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.

DRAWING NO. : DS-74-18-XXXX DATE : 2018-8-10 PAGE 7 of 13



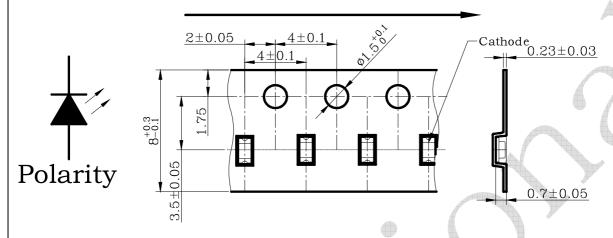


Part No.: L-C191LGCT-BIC-5A

REV:A/0

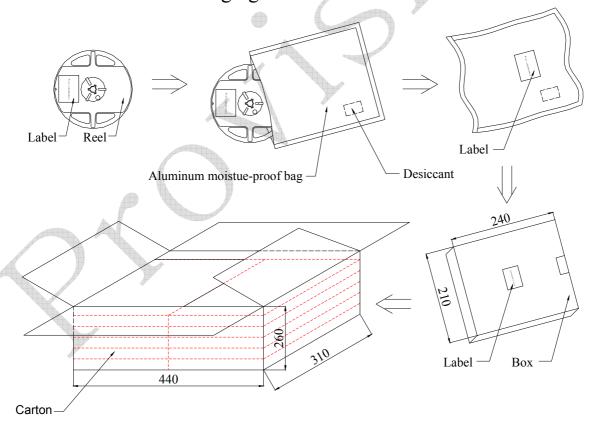
Package Dimensions Of Tape And Reel

Progressive direction



Notes: All dimensions are in millimeters.

Moisture Resistant Packaging



Notes: One reel in a bag, six bag in a inner box, six inner boxes in a carton. Unit: mm.

DRAWING NO. : DS-74-18-XXXX DATE : 2018-8-10 PAGE 8 of 13





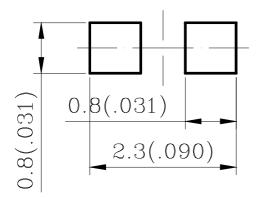
Part No.: L-C191LGCT-BIC-5A

REV:A/0

Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- * Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions



Direction of PWB camber and go to reflow furnace

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 9 of 13

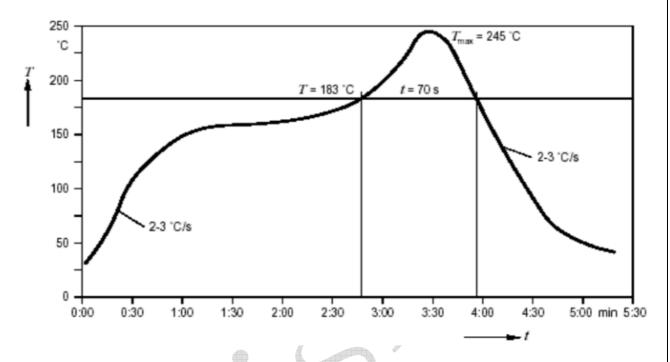




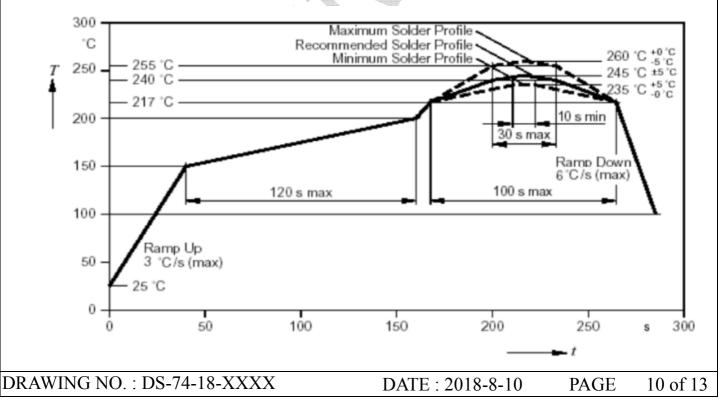
Part No.: L-C191LGCT-BIC-5A

REV:A/0

• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



• Suggest Pb-Free IR Reflow Soldering Profile Condition:



PARA-FOR-068





Part No.: L-C191LGCT-BIC-5A

REV:A/0

CAUTIONS

1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature: 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time: 3 sec. Max.(one time only), power dissipation of iron: 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 11 of 13





Part No.: L-C191LGCT-BIC-5A

REV:A/0

4. Lead-Free Soldering

For Reflow Soldering:

- 1 · Pre-Heat Temp:150-180°C,120sec.Max.
- 2 · Soldering Temp:Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3 · Peak Temperature: 260° € · 5sec.
- 4 · Reflow Repetition:2 Times Max.
- 5 · Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

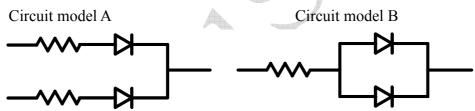
For Soldering Iron (Not Recommended):

- 1 · Iron Tip Temp:350°C Max.
- 2 · Soldering Iron:30w Max.
- 3 · Soldering Time: 3 Sec. Max. One Time.

For Dip Soldering:

- 1 · Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2 · Bath Temp:265°C Max.
- 3 \ Dip Time: 5 Sec. Max.

5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

DRAWING NO.: DS-74-18-XXXX DATE: 2018-8-10 PAGE 12 of 13



REV:A/0



SURFACE MOUNT DEVICE LED

Part No.: L-C191LGCT-BIC-5A

6.Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5 °C Test Time= 1000HRS (-24HRS,72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,72H RS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	105±5℃ -55±5℃ 10mins 10mins 100 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
Environmental	Thermal Shock	IR-Reflow In-Board, 2 Times $105\pm5^{\circ}\text{C}$ $-55^{\circ}\text{C}\pm5^{\circ}\text{C}$ 10mins 10mins 100 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Test	Solder Resistance	Tsol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 sec	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	Solder ability	Tsol= 235 ± 5 °C Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

DRAWING NO. : DS-74-18-XXXX DATE : 2018-8-10 PAGE 13 of 13